

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5195429

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SAIRAM VEERASWAMY	06/01/2017
RECEIVING PARTY DATA	
Name:	EMC IP HOLDING COMPANY LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15081246
CORRESPONDENCE DATA	
Fax Number:	(631)393-6271
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	631-393-6270
Email:	nyoffice@rml-law.com
Correspondent Name:	WILLIAM E. LEWIS
Address Line 1:	48 SOUTH SERVICE ROAD, SUITE 100
Address Line 2:	RYAN, MASON & LEWIS, LLP
Address Line 4:	MELVILLE, NEW YORK 11747
ATTORNEY DOCKET NUMBER:	EMC-16-0018
NAME OF SUBMITTER:	WILLIAM E. LEWIS
SIGNATURE:	/william e. lewis/
DATE SIGNED:	10/16/2018
Total Attachments: 4	
source=4414-581_ASM3#page1.tif	
source=4414-581_ASM3#page2.tif	
source=4414-581_ASM3#page3.tif	
source=4414-581_ASM3#page4.tif	

ASSIGNMENT

WHEREAS, we, Sairam Veeraswamy and Upanshu Singhal, have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled **DATA PROTECTION ANALYTICS IN CLOUD COMPUTING PLATFORM**, the specification of which:

☐ is being executed on even date herewith and is about to be filed in the United States Patent Office;

☒ was filed on March 25, 2016 as U.S. Application No. 15/081,246;

☐ was patented under U.S. Patent No. _____ on _____.

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a limited liability company organized and existing under the laws of the State of Delaware and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the

giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date: 06/01/2017



Inventor's Signature

Print full name of first inventor:

Sairam Veeraswamy

Residence:

Coimbatore, Tamil Nadu, India

Citizenship:

India

Mailing Address:

C320 - Manchester Grand
MG Road, Avarampalayam
Coimbatore, Tamil Nadu, India 641006

Date

Witness #1 Signature

Witness #1 Print Name

Date

Witness #2 Signature

Witness #2 Print Name

Date:

Inventor's Signature

Print full name of second inventor:

Upanshu Singhal

Residence:

Bangalore, Karnataka, India

Citizenship:

India

Mailing Address:

D-301, Habitat Splendour
ITPL Road, Kundanhalli Post
Bangalore, Karnataka, India 560037

Date

Witness #1 Signature

Witness #1 Print Name

Date

Witness #2 Signature

Witness #2 Print Name